

DESCRIPTION:

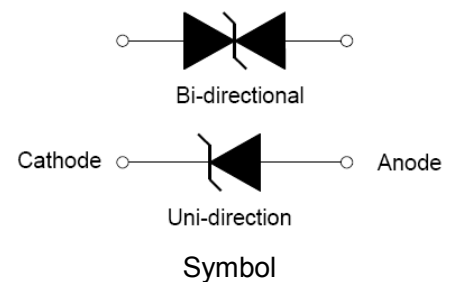
TVS diodes can be used in a wide range of applications which like consumer electronic products, automotive industries, munitions, telecommunications, aerospace industries, and intelligent control systems.



SMA

FEATURES:

- ✧ Glass passivated or planar junction
- ✧ Excellent clamping capability
- ✧ Repetition rate (duty cycle): 0.01%
- ✧ Typical I_R less than $1\mu A$ above 10V.
- ✧ Low profile package and low inductance
- ✧ 400W Peak Pulse power capability at $10 \times 1000\mu s$ waveform.
- ✧ Fast response time: typically less than 1.0ps from 0V to V_{BR} min.
- ✧ High temperature soldering: $260^\circ C/10s$ at terminals.
- ✧ Plastic package has Underwriters Laboratory Flammability 94V-0.
- ✧ For surface mounted applications in order to optimize board space
- ✧ AEC-Q101 qualified.



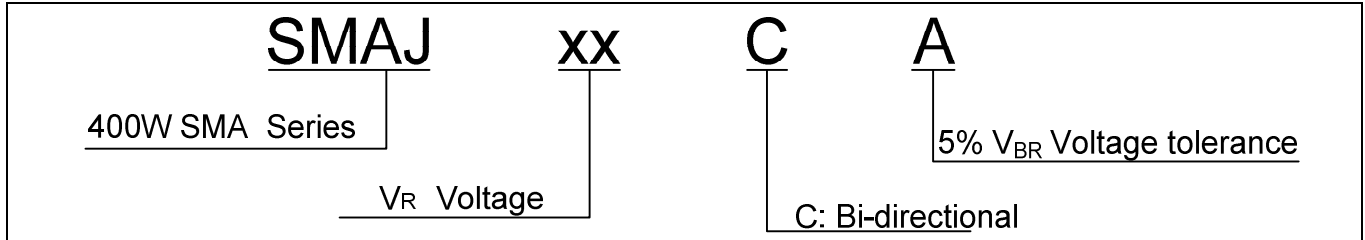
ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ C$, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Storage temperature range	T_{stg}	-55 to +125	$^\circ C$
Operating junction temperature range	T_j	-55 to +125	$^\circ C$
Steady state power dissipation at $T_L=75^\circ C$	$P_{M(AV)}$	3.3	W
Peak pulse power dissipation on 10/1000 μs waveform	P_{PP}	400	W
Maximum Instantaneous Forward Voltage at 30A for Unidirectional	V_F	5.0	V

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$)

Part Number		V_R	$I_R@V_R$	$V_{BR}@I_T$		I_T	$V_C@I_{PP}$	$I_{PP}^{①}$
Uni-Polar	Bi-Polar	V	μA	min(V)	max(V)	mA	max(V)	A
SMAJ6.8A	SMAJ6.8CA	5.8	300	6.55	7.15	10	9.5	42.8

ORDERING INFORMATION



RATINGS AND V-I CHARACTERISTICS CURVES ($T_A=25^\circ\text{C}$, unless otherwise noted)

FIG.1: V- I curve characteristics (Uni-directional)

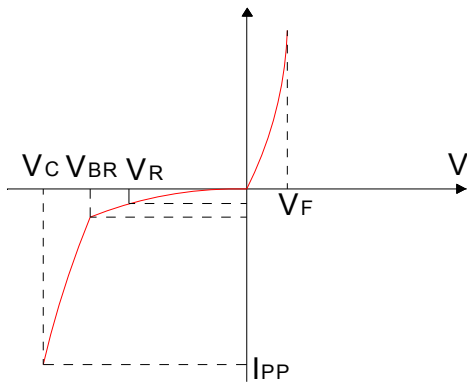


FIG.2: V- I curve characteristics (Bi-directional)

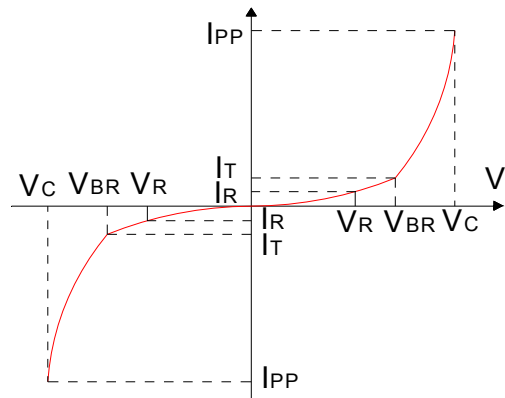


FIG.3: Pulse waveform

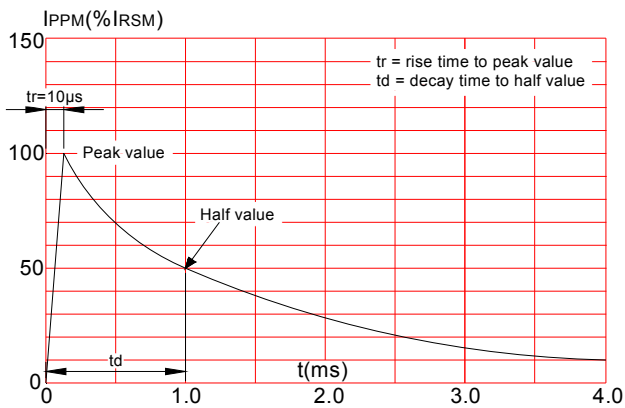
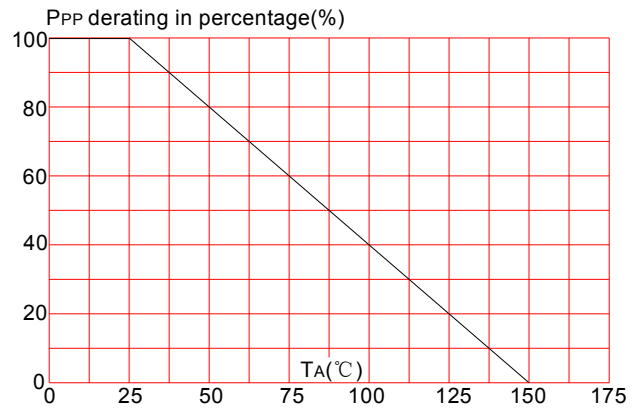
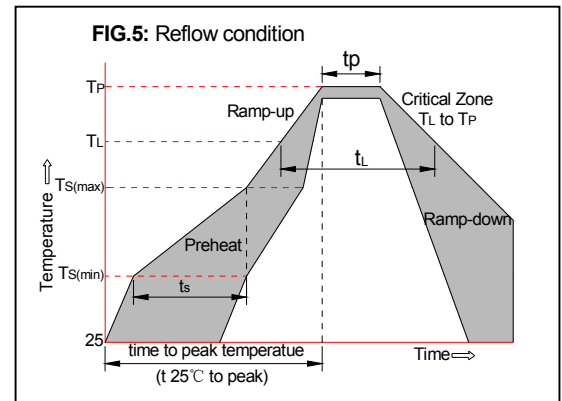


FIG.4: Pulse derating curve

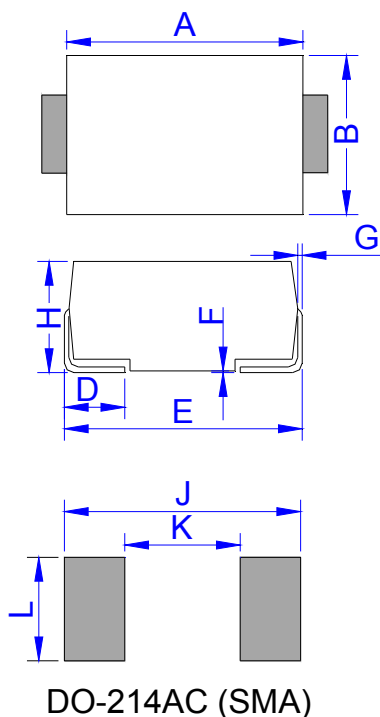


SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see FIG.5)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_p)		8 min. Max
Do not exceed		+260°C

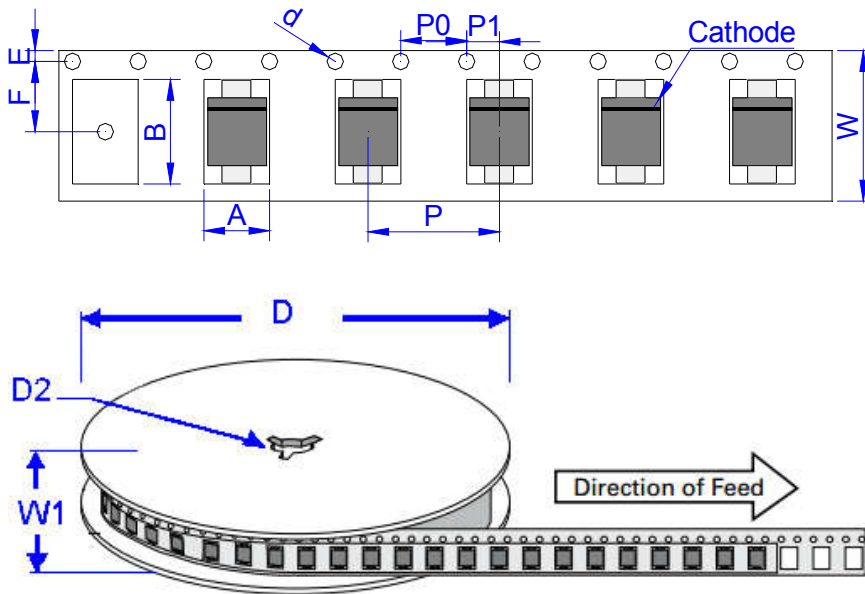


PACKAGE MECHANICAL DATA



Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.00	4.65	0.157	0.183
B	2.30	2.90	0.091	0.114
C	1.35	1.65	0.053	0.065
D	0.76	1.52	0.030	0.060
E	4.70	5.28	0.185	0.208
F	0.051	0.203	0.002	0.008
G	0.15	0.31	0.006	0.012
H	1.90	2.41	0.075	0.095
J	6.50		0.256	
K		2.30		0.090
L	1.70		0.067	

TAPE AND REEL SPECIFICATION-SMA



Ref.	Dimensions	
	Millimeters	Inches
A	2.79 ± 0.3	0.110 ± 0.012
B	5.33 ± 0.3	0.210 ± 0.012
d	1.5 ± 0.1	0.059 ± 0.004
D	330.0	13.0
D2	13 ± 1	0.512 ± 0.039
E	1.5 ± 0.2	0.059 ± 0.008
F	5.65 ± 0.2	0.222 ± 0.008
P	4.0 ± 0.2	0.157 ± 0.008
P0	4.0 ± 0.2	0.157 ± 0.008
P1	2.0 ± 0.2	0.079 ± 0.008
W	12.0 ± 0.2	0.472 ± 0.008
W1	16.8 ± 2.0	0.661 ± 0.079

OUTLINE	REEL (PCS)	PER CARTON (PCS)	REEL DIAMETERS (mm)
TAPING	5,000	80,000	330

单击下面可查看定价，库存，交付和生命周期等信息

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